

plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack"

8 February 2016

Package information

1. Package summary

Terminal position codeS (single)Package type descriptive codeTO-220FPackage type industry codeTO-220F

Package style descriptive code SFM (single-ended flange mount)

Package style suffix code NA (not applicable)

Package body material typeP (plastic)JEDEC package outline code3-lead TO-220FMounting method typeH (heatsink mount)

Issue date 14-2-2006

Table 1. Package summary

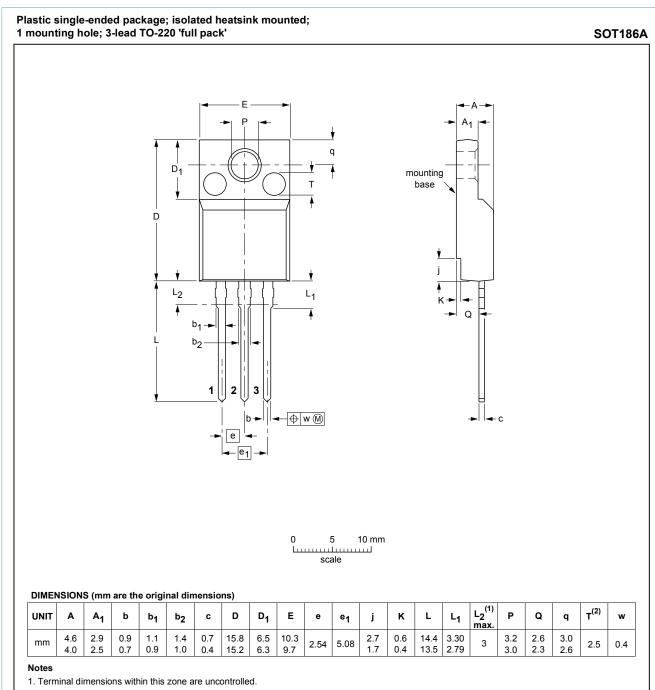
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	15.2	-	15.5	15.8	mm
Е	package width	9.7	-	10	10.3	mm
Α	seated height	4	-	4.3	4.6	mm
е	nominal pitch	-	-	2.54	-	mm
n ₂	actual quantity of termination	-	-	3	-	



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2. Package outline



2. Both recesses are # 2.5×0.8 max. depth

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT186A		3-lead TO-220F				-02-04-09 06-02-14

Fig. 1. Package outline TO-220F (SOT186A)

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3. Legal information

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